

# 133MHz Clock Generator and Integrated Buffer for PowerPC™

#### **Recommended Application:**

#### Power PC System Clock

**Output Features:** 

- 12- CPUs @ 3.3V, up to 146MHz
- 1- PCIREF @ 3.3V, up to 73MHz
- 1 OUT 3.3V, 64MHz
- 1 OUT/2 3.3V, OUT/2MHz
- 2 REF @ 3.3V, 14.318MHz

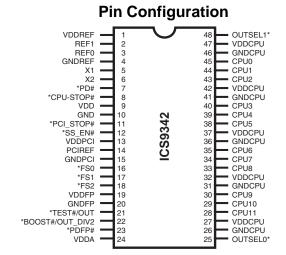
#### **Features:**

- Up to 146MHz frequency support
- Support power management: CPU, PCI stop and power down mode.
- Spread spectrum for EMI control (0 to -0.5%,  $\pm 0.25\%$ ).
- Uses external 14.318MHz crystal
- FS pins for frequency select
- Support for industrial temperature range (-40 $^{\circ}$  to 85 $^{\circ}$ )

#### **Key Specifications:**

**Block Diagram** 

- CPU Output Skew: <200ps
- CPU PCI Output Skew: <500ps
- CPU Output Jitter: <150ps
- PCI Output Jitter: <500ps



#### 48-Pin 300mil SSOP

\* Internal pull-up resistor of 120K to VDD on indicated inputs.

-		
Sp		OUT/DIV2 I OUT/DIV2 I I I I I CPUCLK (11:0) I
55_EN#	ontrol	
	onfig. Reg.	

#### Functionality

TEST	FS2	FS1	FS0	CPU MHz	PCI MHz	REF MHz
1	1	1	1	133.33	33.33	14.318
1	1	1	0	100.00	33.33	14.318
1	1	0	1	83.33	33.33	14.318
1	1	0	0	66.66	33.33	14.318
1	0	1	1	133.33	66.66	14.318
1	0	1	0	100.00	66.66	14.318
1	0	0	1	83.33	66.66	14.318
1	0	0	0	66.66	66.66	14.318

9342 Rev E 9/06/00

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## ICS9342

# ICS9342



#### **General Description**

The ICS9342 generates all clocks required for high speed PowerPC RISC microprocessor systems. With a zero delay buffer chip such as the ICS9112-17 multiple PCI clock outputs can be generated in phase with PCIREF.

Spread Spectrum may be enabled by driving the SS\_EN# pin low. Spread spectrum typically reduces system EMI by 8dB to 10dB. This simplifies EMI qualification without resorting to board design iterations or costly shielding. The **ICS9342** employs a proprietary closed loop design, which tightly controls the percentage of spreading over process and temperature variations.

#### **Pin Configuration**

PIN NUMBER	PIN NAME	TYPE	DESCRIPTION
1	VDDREF	PWR	Ref(1:0), XTAL power supply, nominal 3.3V
2,3	REF[1:0]	OUT	14.318 MHz reference clocks
4	GNDREF	PWR	Ground pin for the REF outputs
5	X1	IN	Crystal input, nominally 14.318MHz.
6	X2	OUT	Crystal output, nominally 14.318MHz.
7	PD#	IN	Powers down chip, active low.
8	CPU_STOP#	IN	Stops all CPUCLKs [11:0] at logic 0 level, when input low
9	VDD	PWR	3.3V power for the digital core.
10	GND	PWR	Ground pin for the digital core.
11	PCI_STOP#	IN	Drives PCIREF to logic 0 level, when input low
12	SS_EN#	IN	Spread spectrum is turned on by driving this input low and turned off by
12	55_EN#	111	driving it high.
13	VDDPCI	PWR	Power supply for PCIREF, nominal 3.3V.
14	PCIREF	OUT	Reference clock for PCI Zero Delay Buffer.
15	GNDPCI	PWR	Ground pin for PCIREF.
18, 17, 16	FS (2:0)	IN	Frequency select pins.
19	VDDFP	PWR	3.3V power for the Fixed PLL core.
20	GNDFP	PER	Ground pin for the Fixed PLL core.
	OUT	OUT	3.3V OUT reference clock.
21	TEST#	IN	Logic input to select over clocking or under clocking frequencies.
		11N	(latched input)
22	OUT_DIV2	OUT	3.3V 1/2 frequency OUT reference clock.
22	BOOST#	IN	Logic input to select normal or test mode frequencies. (latched input)
23	PDFP#	IN	Powers down Fixed PLL. When driven to low, OUT and OUT_DIV2 clocks
23	1 D1 1 #	114	will be stopped
24	VDDA	PWR	3.3V power for the PLL core
48, 25	OUTSEL(1:0)	IN	Frequency select pins for OUT and OUT_DIV2 clocks.
26, 31, 36, 41, 46	GNDCPU	PWR	Ground pin for CPU clocks.
27, 32, 37, 42, 47	VDDCPU	PWR	3.3V power supply for CPU clocks.



# ICS9342

## **Frequency Selection**

BOOST#	TEST#	FS2	FS1	FS0	CPU MHz	PCI MHz	REF MHz	SS TYPE/VALUE If SS enabled	
Х	1	1	1	1	133.33	33.33	14.318	0 to -0.5% Down Spread	
Х	1	1	1	0	100.00	33.33	14.318	0 to -0.5% Down Spread	
Х	1	1	0	1	83.33	33.33	14.318	0 to -0.5% Down Spread	
Х	1	1	0	0	66.66	33.33	14.318	0 to -0.5% Down Spread	
Х	1	0	1	1	133.33	66.66	14.318	0 to -0.5% Down Spread	
Х	1	0	1	0	100.00	66.66	14.318	0 to -0.5% Down Spread	
Х	1	0	0	1	83.33	66.66	14.318	0 to5% Down Spread	
Х	1	0	0	0	66.66	66.66	14.318	0 to -0.5% Down Spread	
1	0	1	1	1	146.62	36.6	14.318	+ 0.25% Center Spread	
1	0	1	1	0	109.99	36.6	14.318	+ 0.25% Center Spread	
1	0	1	0	1	91.58	36.6	14.318	+ 0.25% Center Spread	
1	0	1	0	0	73.31	36.6	14.318	+ 0.25% Center Spread	
1	0	0	1	1	146.62	73.3	14.318	+ 0.25% Center Spread	
1	0	0	1	0	109.99	73.3	14.318	+ 0.25% Center Spread	
1	0	0	0	1	91.58	73.3	14.318	+ 0.25% Center Spread	
1	0	0	0	0	73.31	73.3	14.318	+ 0.25% Center Spread	
0	0	1	1	1	119.98	30.00	14.318	+ 0.25% Center Spread	
0	0	1	1	0	90.00	30.00	14.318	+ 0.25% Center Spread	
0	0	1	0	1	74.93	30.00	14.318	+ 0.25% Center Spread	
0	0	1	0	0	Test Mode, CPU=Ref/4, PCI=Ref/8				
0	0	0	1	1	119.98	60.00	14.318	+ 0.25% Center Spread	
0	0	0	1	0	90.00	60.00	14.318	+ 0.25% Center Spread	
0	0	0	0	1	74.93	60.00	14.318	+ 0.25% Center Spread	
0	0	0	0	0	Tristate, a	ll outputs			

OUT_SEL1	OUT_SEL0	OUT (MHz)	OUT_DIV2 (MHz)	REF (MHz)
1	1	48	24	14.318
1	0	40	20	14.318
0	1	64	32	14.318
0	0	48	48#	14.318



#### **Absolute Maximum Ratings**

Supply Voltage	7.0 V
Logic Inputs	$\dots$ GND -0.5 V to V <sub>DD</sub> +0.5 V
Ambient Operating Temperature	$\dots$ -40°C to +85°C
Storage Temperature	$\dots$ -65°C to +150°C

Stresses above those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These ratings are stress specifications only and functional operation of the device at these or any other conditions above those listed in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

## **Electrical Characteristics - Input/Supply/Common Output Parameters**

in the second	TA = 0 10 C, Supply Tokage TB = 5.5 T 17 5% (unless otherwise stated)								
PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS			
Input High Voltage	$V_{IH}$		2		V <sub>DD</sub> +0.3	V			
Input Low Voltage	V <sub>IL</sub>		V <sub>SS</sub> -0.3		0.8	V			
Input High Current	I <sub>IH</sub>	$V_{IN} = V_{DD}$		0.1	5	μA			
Input Low Current	I <sub>IL1</sub>	$V_{IN} = 0$ V; Inputs with no pull-up resistors	-5	2.0		μA			
Input Low Current	I <sub>IL2</sub>	$V_{IN} = 0$ V; Inputs with pull-up resistors	-200	-100		μA			
	I <sub>DD3.3OP66</sub>	Select @ 66MHz; Max discrete cap loads		134	175				
Operating	I <sub>DD3.3OP83</sub>	Select @ 83MHz; Max discrete cap loads		165	200	mA			
Supply Current	I <sub>DD3.30P100</sub>	Select @ 100MHz; Max discrete cap loads		198	225	ША			
	I <sub>DD3.30P133</sub>	Select @ 133MHz; Max discrete cap loads		254	300				
Power Down Supply Current	Idd3.3pd	PD# = 0		313	400	μΑ			
Input frequency	F <sub>i</sub>	$V_{DD} = 3.3 V$	12	14.318	16	MHz			
Level Constituted	C <sub>IN</sub>	Logic Inputs			5	pF			
Input Capacitance <sup>1</sup>	C <sub>INX</sub>	X1 & X2 pins	13.5	18	22.5	pF			
Transition Time <sup>1</sup>	T <sub>Trans</sub>	To 1st crossing of target Freq.			3	ms			
Settling Time <sup>1</sup>	Ts	From 1st crossing to 1% target Freq.		1		ms			
Clk Stabilization <sup>1</sup>	T <sub>STAB</sub>	From $V_{DD} = 3.3$ V to 1% target Freq.			3	ms			
Skew <sup>1</sup>	tcpu-pci	$V_{\rm T} = 1.5 \ {\rm V}$		190	500	ps			

 $T_A$  = 0 - 70° C; Supply Voltage V\_DD = 3.3 V +/-5% (unless otherwise stated)



## **Electrical Characteristics - CPU**

 $T_A = 0 - 70^{\circ} \text{ C}; V_{DD} = 3.3 \text{ V} + -5\%; C_L = 20 \text{ pF} \text{ (unless otherwise stated)}$ 

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Impedance	Rdsp2b <sup>1</sup>	$V_{\rm O} = V_{\rm DD} * (0.5)$	13.5	20	45	Ω
Output Impedance	Rdsn2b <sup>1</sup>	$V_{\rm O} = V_{\rm DD} * (0.5)$	13.5	29	45	Ω
Output High Voltage	V <sub>OH2B</sub>	$I_{OH} = -8.0 \text{ mA}$	2	2.4		V
Output Low Voltage	V <sub>OL2B</sub>	$I_{OL} = 12 \text{ mA}$		0.32	0.4	V
Output High Current	I <sub>OH2B</sub>	V <sub>OH</sub> =1.7 V		-37	-16	mA
Output Low Current	I <sub>OL2B</sub>	$V_{OL} = 0.7 V$	19	26		mA
Rise Time	$t_{r2B}^{1}$	$V_{OL} = 0.4 V, V_{OH} = 2.4 V$		1.13	2	ns
Fall Time	t <sub>f2B</sub> <sup>1</sup>	$V_{OH} = 2.4 \text{ V}, V_{OL} = 0.4 \text{ V}$		1.27	2	ns
Duty Cycle	$d_{t2B}^{1}$	VT = 1.5 V; Cpu@ 66M, 83M, 100M	45	52	56	%
Duty Cycle	u <sub>t2B</sub>	VT = 1.5 V; Cpu@133M & 146.6M	51	56	60	70
Skew	t <sub>sk2B</sub> <sup>1</sup>	VT = 1.5 V		187	200	ps
		VT = 1.5 V; Normal		95	150	
Jitter, Cycle-to-cycle	tj <sub>cyc-cyc2B</sub> <sup>1</sup>	VT = 1.5 V; Spread, CPU = 91.58MHz		143	200	ps
	· ·	VT = 1.5 V; Spread, CPU remaining freq.		143	175	

<sup>1</sup>Guaranteed by design, not 100% tested in production.

## **Electrical Characteristics - PCI**

 $T_A = 0 - 70^{\circ} \text{ C}; V_{DD} = 3.3 \text{ V} + -5\%; C_L = 30 \text{ pF}$ 

$r_{\rm A} = 0$ 70 °C, $r_{\rm DD} = 5.5$ ° 17 570, $c_{\rm L} = 50$ pr							
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
Output Impedance	$R_{DSP1}^{1}$	$V_0 = V_{DD}^{*}(0.5)$	12	21	55	Ω	
Output Impedance	$R_{DSN1}^{1}$	$V_0 = V_{DD}^{*}(0.5)$	12	21.2	55	Ω	
Output High Voltage	V <sub>OH1</sub>	$I_{OH} = -11 \text{ mA}$	2.4				
Output Low Voltage	V <sub>OL1</sub>	$I_{OL} = 9.4 \text{ mA}$		0.17	0.4	V	
Output High Current	I <sub>OH1</sub>	$V_{OH} = 2.0 V$		-60	-22	mA	
Output Low Current	I <sub>OL1</sub>	$V_{OL} = 0.8 V$	25	47		mA	
Rise Time <sup>1</sup>	t <sub>r1</sub>	$V_{OL} = 0.4 \text{ V}, V_{OH} = 2.4 \text{ V}$	0.5	1	2	ns	
Fall Time <sup>1</sup>	t <sub>f1</sub>	$V_{OH} = 2.4 \text{ V}, V_{OL} = 0.4 \text{ V}$	0.5	0.9	2	ns	
Duty Cycle <sup>1</sup>	d <sub>t1</sub>	$V_{\rm T} = 1.5  {\rm V}$	45	50	55	%	
Jitter, Cycle-to-cycle <sup>1</sup>	t <sub>jcyc-cyc1</sub>	$V_{\rm T} = 1.5  {\rm V}$		170	500	ps	

<sup>1</sup>Guaranteed by design, not 100% tested in production.



## **Electrical Characteristics - REF, OUT, OUT/2**

PARA	AMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Impedance		Rdsp5 <sup>1</sup>	$V_{\rm O} = V_{\rm DD} * (0.5)$	20	34	60	Ω
Output	Impedance	Rdsn5 <sup>1</sup>	$V_{\rm O} = V_{\rm DD} * (0.5)$	20	31	60	Ω
Output H	ligh Voltage	Voh5	Іон = -12 mA	2.4	2.9		V
Output I	Low Voltage	Vol5	IOL = 10  mA		0.33	0.4	V
Output H	ligh Current	Іон5	Vон = 2.0 V		-30	-20	mA
Output l	Low Current	Iol5	$V_{OL} = 0.8 V$	16	23		mA
	Rise Time <sup>1</sup>	tr5	$V_{OL} = 0.4 \text{ V}, V_{OH} = 2.4 \text{ V}; \text{ OUT}$	1.5	1.8	4	ns
REF	Fall Time <sup>1</sup>	tß	Voh = 2.4 V, Vol = 0.4 V; OUT	1.5	2	4	ns
	Duty Cycle <sup>1</sup>	dt5	V <sub>T</sub> = 1.5 V; OUT	45	52	55	%
	Rise Time <sup>1</sup>	tr5	Vol = 0.4 V, Voh = 2.4 V; OUT/2	1.5	2.2	4	ns
OUT	Fall Time <sup>1</sup>	tß	Voh = 2.4 V, Vol = 0.4 V; OUT/2	1.5	2.1	4	ns
	Duty Cycle <sup>1</sup>	dt5	V <sub>T</sub> = 1.5 V; OUT/2	45	50	55	%
	Rise Time <sup>1</sup>	tr5	Vol = 0.4 V, Voh = 2.4 V; REF	1.5	2.7	4	ns
OUT/2	Fall Time <sup>1</sup>	tß	Voh = 2.4 V, Vol = 0.4 V; REF	1.5	2.8	4	ns
	Duty Cycle <sup>1</sup>	dt5	V <sub>T</sub> = 1.5 V; REF	45	50	55	%
Jitter, Cy	Jitter, Cycle-to-cycle1		VT = 1.5 V; OUT, OUT/2		280	500	ps
Jitter, Cy	cle-to-cycle <sup>1</sup>	t <sub>jcyc-cyc5</sub>	$V_{T} = 1.5 V; REF$		450	1000	ps

 $T_A = 0 - 70^{\circ} \text{ C}; V_{DD} = 3.3 \text{ V} + -5\%; C_L = 20 \text{ pF} \text{ (unless otherwise stated)}$ 

<sup>1</sup>Guaranteed by design, not 100% tested in production.

ICS9342



# Shared Pin Operation - Input/Output Pins

The I/O pins designated by (input/output) on the ICS9342 serve as dual signal functions to the device. During initial power-up, they act as input pins. The logic level (voltage) that is present on these pins at this time is read and stored into a 5-bit internal data latch. At the end of Power-On reset, (see AC characteristics for timing values), the device changes the mode of operations for these pins to an output function. In this mode the pins produce the specified buffered clocks to external loads.

To program (load) the internal configuration register for these pins, a resistor is connected to either the VDD (logic 1) power supply or the GND (logic 0) voltage potential. A 10 Kilohm (10K) resistor is used to provide both the solid CMOS programming voltage needed during the power-up programming period and to provide an insignificant load on the output clock during the subsequent operating period. Figure 1 shows a means of implementing this function when a switch or 2 pin header is used. With no jumper is installed the pin will be pulled high. With the jumper in place the pin will be pulled low. If programmability is not necessary, than only a single resistor is necessary. The programming resistors should be located close to the series termination resistor to minimize the current loop area. It is more important to locate the series termination resistor close to the driver than the programming resistor.

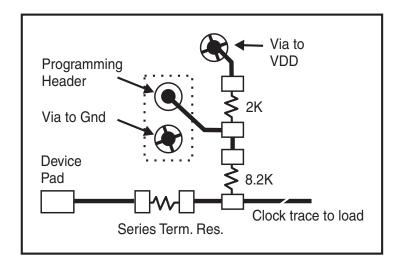


Fig. 1



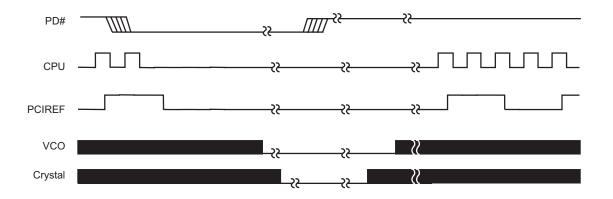
## **Power Management**

PD#	PDFP#	OUT1, OUT_DIV2	CPU, PCI, REF
1	1	RUNNING	RUNNING
1	0	STOPPED	RUNNING
0	1	STOPPED	STOPPED
0	0	STOPPED	STOPPED

## **PD#** Timing Diagram

The power down selection is used to put the part into a very low power state without turning off the power to the part. PD# is an asynchronous active low input. This signal needs to be synchronized internal to the device prior to powering down the clock synthesizer.

Internal clocks are not running after the device is put in power down. When PD# is active low all clocks need to be driven to a low value and held prior to turning off the VCOs and crystal. The power up latency needs to be less than 3 mS. The power down latency should be as short as possible but conforming to the sequence requirements shown below. The REF and OUT clocks are expected to be stopped in the LOW state as soon as possible. Due to the state of the internal logic, stopping and holding the REF clock outputs in the LOW state may require more than one clock cycle to complete.



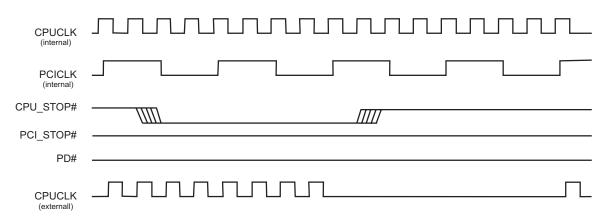
#### Notes:

- 1. All timing is referenced to the Internal CPU (defined as inside the ICS9342 device).
- 2. As shown, the outputs Stop Low on the next falling edge after PD# goes low.
- 3. PD# is an asynchronous input and metastable conditions may exist. This signal is synchronized inside this part.
- 4. The shaded sections on the VCO and the Crystal signals indicate an active clock.
- 5. Diagrams shown with respect to 133MHz. Similar operation when CPU is 100MHz.



## CPU\_STOP# Timing Diagram

CPU\_STOP# is an asynchronous input to the clock synthesizer. It is used to turn off the CPU clocks for low power operation. CPU\_STOP# is asserted asynchronously by the external clock control logic with the rising edge of free running PCI clock (and hence CPU clock) and must be internally synchronized to the external output. All other clocks will continue to run while the CPU clocks are disabled. The CPU clocks must always be stopped in a low state and started in such a manner as to guarantee that the high pulse width is a full pulse.



Notes:

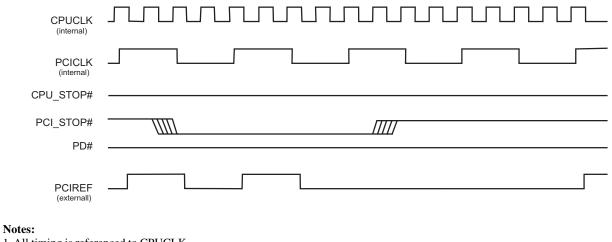
1. All timing is referenced to the internal CPUCLK.

2. The internal label means inside the chip and is a reference only. This in fact may not be the way that the control is designed.

3. PD# and PCI\_STOP# are shown in a high state.

## PCI\_STOP# Timing Diagram

PCI\_STOP# is an input to the clock synthesizer. It is used to turn off the PCIREF clock for low power operation. PCIREF clock is required to be stopped in a low state and started such that a full high pulse width is guaranteed.



1. All timing is referenced to CPUCLK.

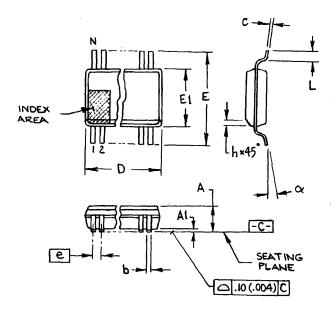
2. Internal means inside the chip.

3. All other clocks continue to run undisturbed.

4. PD# and CPU\_STOP# are shown in a high state.

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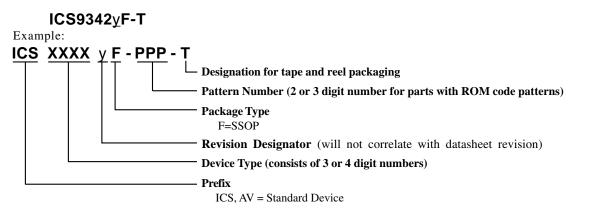
300 mil SSOP

SYMBOL	In Millir	neters	In Inches		
	COMMON D	IMENSIONS	COMMON DIMENSIONS		
	MIN	MAX	MIN	MAX	
А	2.413	2.794	.095	.110	
A1	0.203	0.406	.008	.016	
b	0.203	0.343	.008	.0135	
С	0.127	0.254	.005	.010	
D	SEE VAF	RIATIONS	SEE VARIATIONS		
E	10.033	10.668	.395	.420	
E1	7.391	7.595	.291	.299	
е	0.635	BASIC	0.025 BASIC		
h	0.381	0.635	.015	.025	
L	0.508	1.016	.020	.040	
Ν	SEE VAF	RIATIONS	SEE VARIATIONS		
α	0°	8°	0°	8°	

VARIATIONS

Ν	D mm.		D (inch)	
	MIN	MAX	MIN	MAX
28	9.398	9.652	.370	.380
34	11.303	11.557	.445	.455
48	15.748	16.002	.620	.630
56	18.288	18.542	.720	.730
64	20.828	21.082	.820	.830

## **Ordering Information**



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